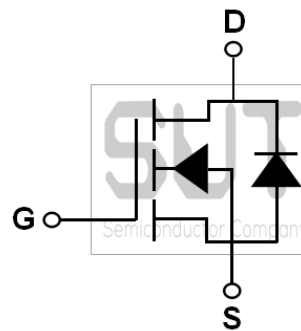
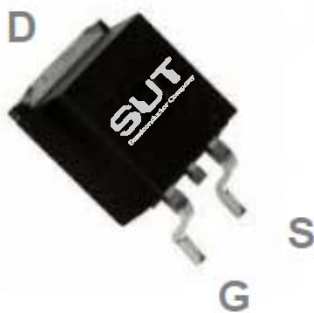


N-Channel 30-V_(D-S) MOSFET

PRODUCT SUMMARY		
B _{VDSS} (V)	R _{DS(on)} (mΩ)(MAX)	I _D (A)
30	1.6@V _{GS} =10V	130

TO263 Pin Configuration



ABSOLUTE MAXIMUM RATINGS(T_C=25°C UNLESS OTHERWISE NOTED)

Parameter	Symbol	Rating	Units
Drain-Source Voltage	V _{DS}	30	V
Gate-Source Voltage	V _{GS}	±20	V
Drain Current-Continuous (T _C =25°C)	I _D	130	A
Drain Current-Continuous (T _C =100°C)		82	A
Drain Current-Pulsed ¹	I _{DM}	520	A
Single Pulse Avalanche Energy ²	EAS	245	mJ
Single Pulse Avalanche Current ²	IAS	70	A
Power Dissipation (T _C =25°C)	P _D	166	W
Power Dissipation-Derate above 25°C		1.33	W/°C
Storage Temperature Range	T _{STG}	-55 to 175	°C
Operating Junction Temperature Range	T _J	-55 to 175	°C

THERMAL CHARACTERISTICS

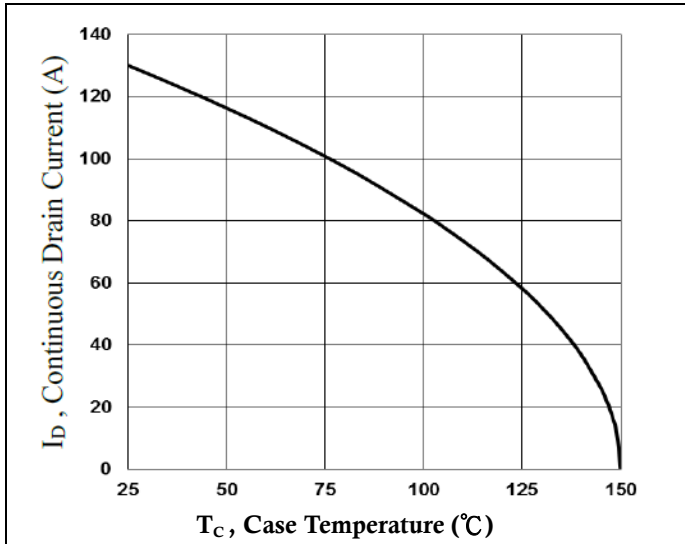
Parameter	Symbol	Typ.	Max.	Unit
Thermal Resistance Junction to ambient	R _{θJA}	---	62	°C/W
Thermal Resistance Junction to Case	R _{θJC}	---	0.9	°C/W

ELECTRICAL CHARACTERISTICS (T _J =25°C UNLESS OTHERWISE NOTED)						
Parameter	Symbol	Test Condition	Min.	Typ.	Max.	Unit
Static State Characteristics						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V, I _D =250uA	30	---	---	V
Drain-Source Leakage Current	I _{DSS}	V _{GS} =0V, V _{DS} =27V, T _J =25°C	---	---	1	uA
		V _{GS} =0V, V _{DS} =24V, T _J =85°C	---	---	10	uA
Gate-Source Leakage Current	I _{GSS}	V _{GS} =±20V, V _{DS} =0V	---	---	±100	nA
Static Drain-Source On-Resistance ³	R _{DS(on)}	V _{GS} =10V, I _D =30A	---	1.2	1.6	mΩ
		V _{GS} =4.5V, I _D =15A	---	1.8	2.4	mΩ
Gate Threshold Voltage	V _{GS(th)}	V _{GS} =V _{DS} , I _D =250uA	1.0	1.6	2.5	V
Forward Transconductance	g _{fs}	V _{DS} =10V, I _D =15A	---	30	---	S
Dynamic and Switching Characteristics						
Total Gate Charge ^{3, 4}	Q _g	V _{GS} =4.5V, V _{DS} =15V, I _D =10A	---	65	120	nC
Gate-Source Charge ^{3, 4}	Q _{gs}		---	16	30	
Gate-Drain Charge ^{3, 4}	Q _{gd}		---	21	40	
Turn-On Delay Time ^{3, 4}	T _{d(on)}	V _{GS} =10V, V _{DD} =15V, R _G =3.3Ω, I _D =1A	---	28	56	ns
Rise Time ^{3, 4}	T _r		---	45	90	
Turn-Off Delay Time ^{3, 4}	T _{d(off)}		---	105	200	
Fall Time ^{3, 4}	T _f		---	40	80	
Input Capacitance	C _{iss}	V _{GS} =0V, V _{DS} =25V, F=1MHz	---	7720	11000	pF
Output Capacitance	C _{oss}		---	945	1400	
Reverse Transfer Capacitance	C _{rss}		---	435	650	
Gate resistance	R _g	V _{GS} =0V, V _{DS} =0V, F=1MHz	---	1.2	2.4	Ω
Guaranteed Avalanche Energy						
Single Pulse Avalanche Energy	EAS	V _{DD} =25V, L=0.1mH, I _{AS} =30A	45	---	---	mJ
Drain-Source Diode Characteristics and Maximum Ratings						
Continuous Source Current	I _S	V _G =V _D =0V, Force Current	---	---	130	A
Pulsed Source Current ³	I _{SM}		---	---	260	A
Diode Forward Voltage ³	V _{SD}	V _{GS} =0V, I _S =1A, T _J =25°C	---	---	1.0	V

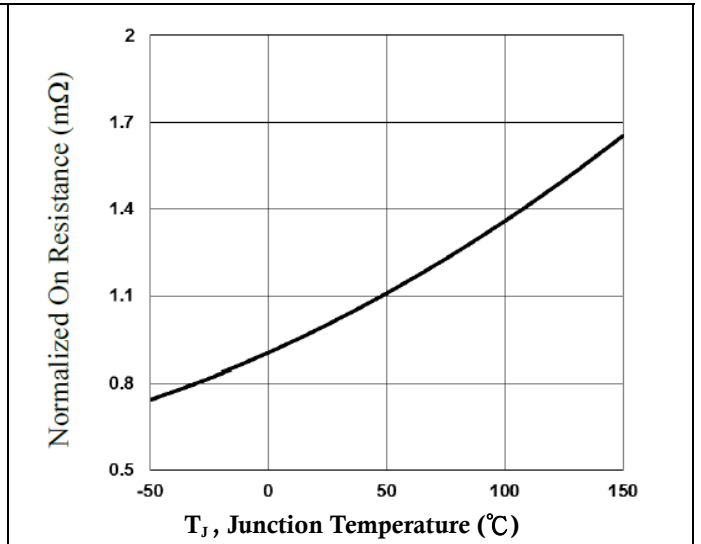
Note :

1. Repetitive Rating : Pulsed width limited by maximum junction temperature.
2. V_{GS}=10V, V_{DD}=25V, L=0.1mH, I_{AS}=70A, R_G=25Ω, Starting T_J=25°C.
3. The data tested by pulsed, pulse width ≤ 300us, duty cycle ≤ 2%.
4. Essentially independent of operating temperature.

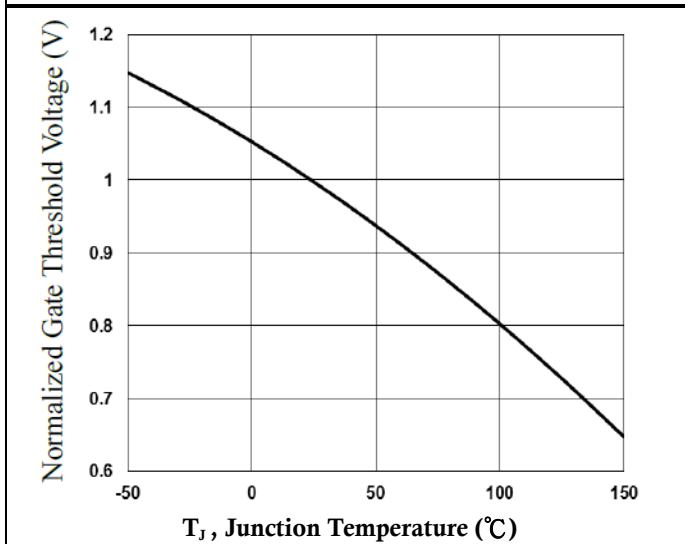
30V N-Channel MOSFETs



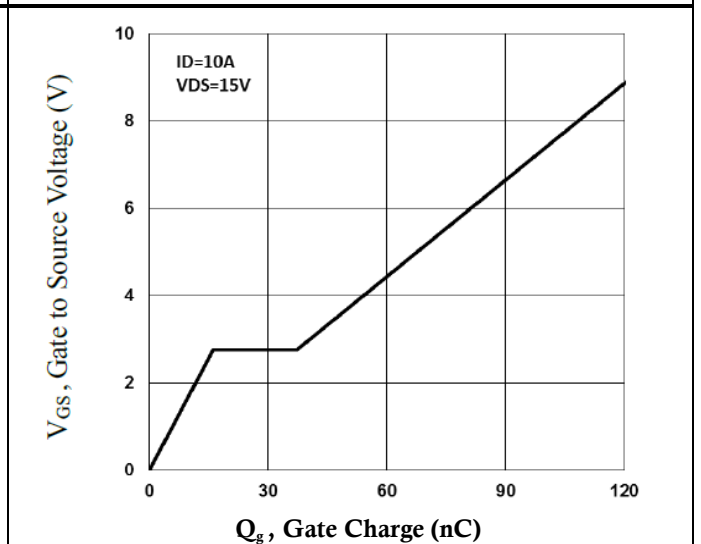
Continuous Drain Current vs. T_C



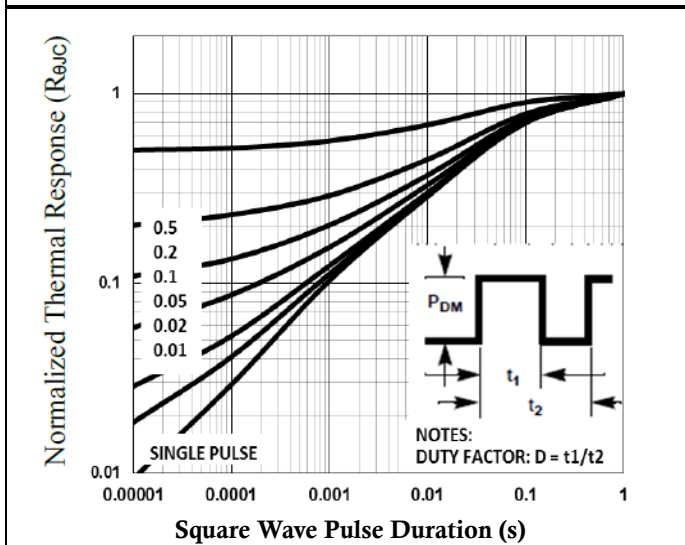
Normalized $R_{DS(ON)}$ vs. T_J



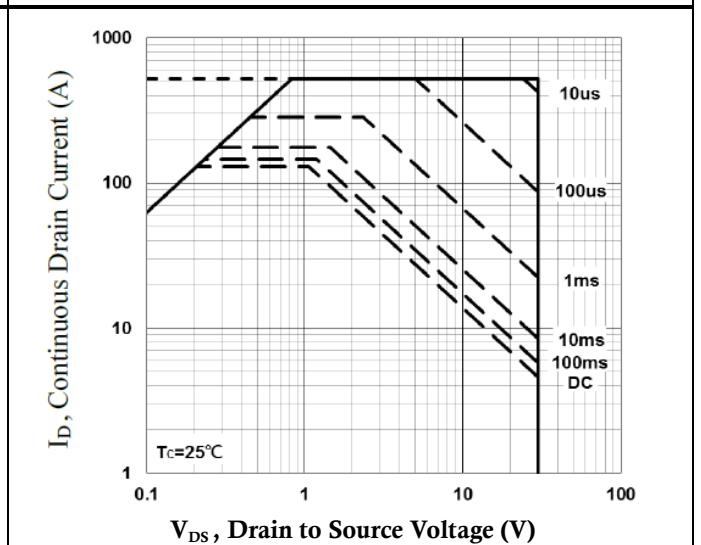
Normalized V_{th} vs. T_J



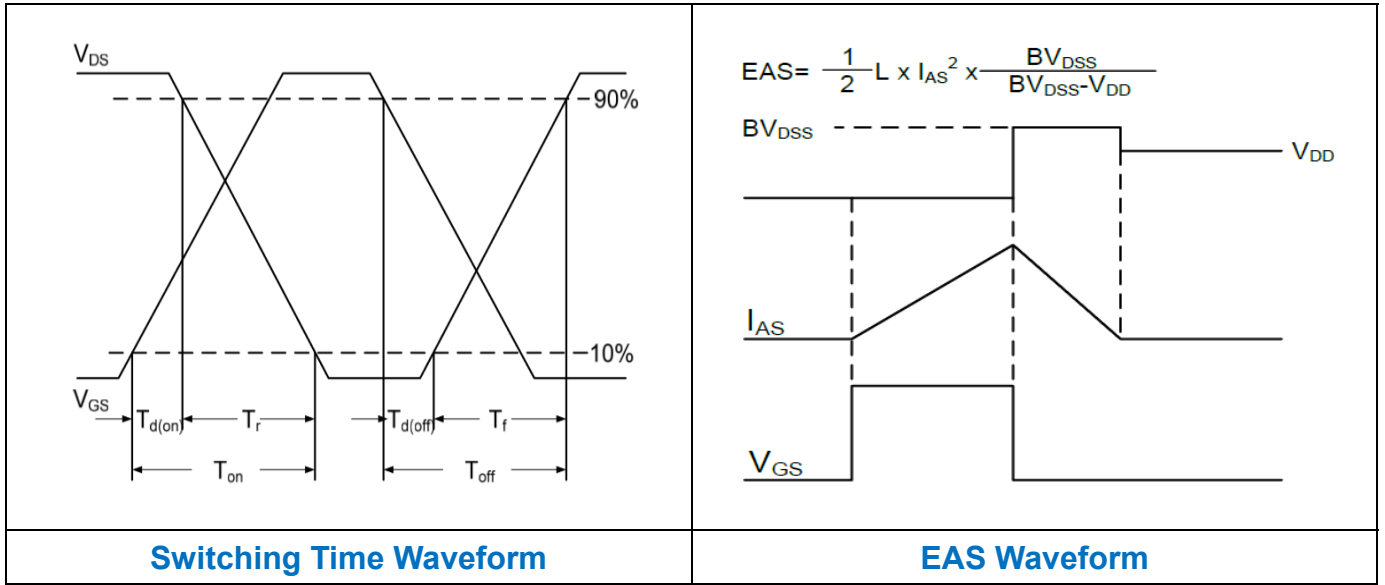
Gate Charge Waveform



Normalized Transient Impedance



Maximum Safe Operation Area



TO263 PACKAGE INFORMATION

